

## KSE13005F

### **High Voltage Switch Mode Application**

- High Speed Switching
- Suitable for Switching Regulator and Motor Control



1.Base 2.Collector 3.Emitter

### **NPN Silicon Transistor**

## Absolute Maximum Ratings T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>CBO</sub>	Collector-Base Voltage	700	V
V <sub>CEO</sub>	Collector-Emitter Voltage	400	V
V <sub>EBO</sub>	Emitter-Base Voltage	9	V
Ic	Collector Current (DC)	4	А
I <sub>CP</sub>	Collector Current (Pulse)	8	Α
$I_{B}$	Base Current	2	Α
P <sub>C</sub>	Collector Dissipation (T <sub>C</sub> =25°C)	30	W
T <sub>J</sub>	Junction Temperature	150	°C
T <sub>STG</sub>	Storage Temperature	- 65 ~ 150	°C

## Electrical Characteristics T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV <sub>CEO</sub>	Collector-Base Breakdown Voltage	$I_C = 10 \text{mA}, I_B = 0$	400			V
I <sub>EBO</sub>	Emitter Cut-off Current	$V_{EB} = 9V, I_{C} = 0$			1	mA
h <sub>FE</sub>	*DC Current Gain	$V_{CE} = 5V, I_{C} = 1A$	10		60	
	7	$V_{CE} = 5V, I_{C} = 2A$	8		40	103
V <sub>CE</sub> (sat)	*Collector-Emitter Saturation Voltage	$I_C = 1A, I_B = 0.2A$			0.5	V
		$I_C = 2A, I_B = 0.5A$	110	- 74	0.6	V
		$I_{C} = 4A, I_{B} = 1A$			1 9	V
V <sub>BE</sub> (sat)	*Base-Emitter Saturation Voltage	$I_C = 1A, I_B = 0.2A$		. W. W.	1.2	V
		$I_C = 2A, I_B = 0.5A$			1.6	V
C <sub>ob</sub>	Output Capacitance	$V_{CB} = 10V$ , $f = 0.1MHz$		65		pF
f <sub>T</sub>	Current Gain Bandwidth Product	$V_{CE} = 10V, I_{C} = 0.5A$	4			MHz
t <sub>ON</sub>	Turn On Time	$V_{CC} = 125V, I_{C} = 2A$			0.8	μs
t <sub>STG</sub>	Storage Time	$I_{B1} = -I_{B2} = 0.4A$			4	μs
t <sub>F</sub>	Fall Time	$R_L = 125\Omega$			0.9	μs

\* Pulse test: PW≤300μs, Duty Cycle≤2%

## **Typical Characteristics**

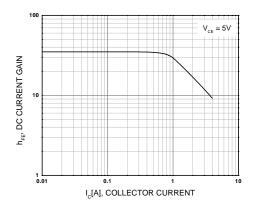


Figure 1. DC current Gain

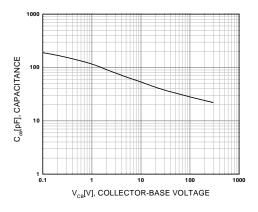


Figure 3. Collector Output Capacitance

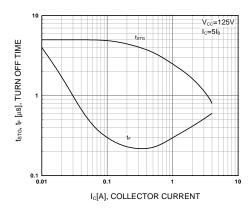


Figure 5. Turn Off Time

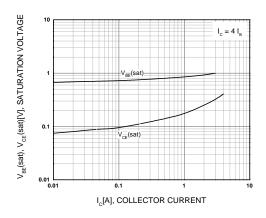


Figure 2. Base-Emitter Saturation Voltage Collector-Emitter Saturation Voltage

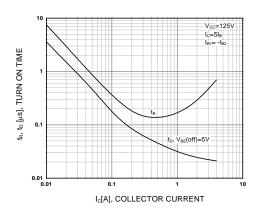


Figure 4. Turn On Time

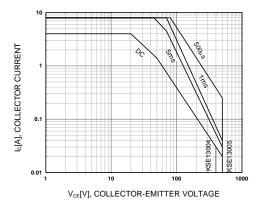


Figure 6. Safe Operating Area

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# Typical Characteristics (Continued)

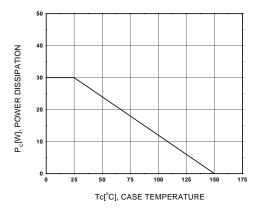
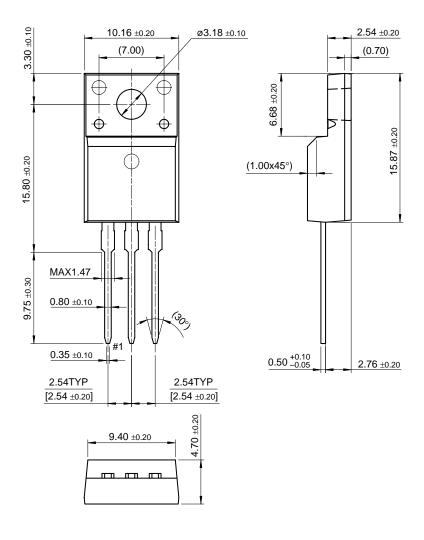


Figure 1. Power Derating

# **Package Demensions**

# TO-220F



Dimensions in Millimeters

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